

PMP9361

Designator	Quantity	Value	PackageReference	PartNumber	Manufacturer
D1	1	0.54V	SOT-26	ZLLS2000TA	Zetex
GND, Vin+, Vin-, Vout	4	Double	Keystone1502-2	1502-2	Keystone
U1	1		IC, μ BGA	LM34919CQTL/NOPB	Texas Instruments
TP1, TP2	2		Socket, 1 mm Single pin	H3185-01	Harwin
C6	1	3300pF	0402	GRM155R71H332KA01D	MuRata
C5, C10	2	0.022uF	0402	GRM155R71H223KA12D	MuRata
Cck1, Cck2	2	10uF	1210	GRM32ER71H106KA12L	MuRata
C3	1	1uF	0805	GRM21BR71H105KA12L	MuRata
C8, C9	2	10uF	0805	GRM21BR71A106KE51L	MuRata
FID1, FID2, FID3	3		Fiducial	N/A	N/A
R6	1	0	0805	ERJ-6GEY0R00V	Panasonic
R4	1	0	0805	CRCW08050000Z0EA	Vishay-Dale
R5	1	787	0402	CRCW0402787RFKED	Vishay-Dale
R2	1	42.2k	0402	CRCW040261K9FKED	Vishay-Dale
R7	1	7.87k	0402	CRCW04027K87FKED	Vishay-Dale
R8	1	2.49k	0402	CRCW04022K49FKED	Vishay-Dale
ComC1	1		Horizontal, 4 Flat Lead	744242510	Würth Electronics Inc
C1	1	0.1uF	0603	C1608X7R1H104K	TDK
Cft	1	1.0 μ F	0603 (1608 Metric)	C1608X5R1H105M080AB	TDK Corporation
C2, C7	2	0.1uF	0402	C1005X7R1H104K	TDK
Lft	1		0806 (2016 Metric)	BRC2016T4R7M	Taiyo Yuden
L1	1	8.2uH	WE-TPC-LH	744053008	Würth Elektronik eiSos
TP4	1	Black	Keystone5011	5011	Keystone
TP3	1	White	Keystone5002	5002	Keystone
C4	1	47 μ F	3024 (7660 Metric)	597D476X9050Z2T	Vishay Sprague

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